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# USB 2.0高速4选2交叉点开关

MAX4989

## 概述

MAX4989为双向、4选2、USB 2.0交叉点开关。MAX4989具有低导通电容和低导通电阻，可支持USB 2.0低速/全速/高速信号，支持高达480Mbps的数据速率。该器件允许4个USB对中的任何2个接在一起，并可通过简单的3路输入控制逻辑接口进行配置。

MAX4989工作于+2.7V至+5.5V单电源，并具有内部电荷泵，提供满摆幅信号。该器件还具有高阻关断模式，使电源电流降低至100nA (典型值)。

MAX4989采用14引脚、3mm x 3mm、TDFN封装，工作于-40°C至+85°C扩展级温度范围。

## 特性

- ◆ +2.7V至+5.5V单电源供电
- ◆ 1 $\mu$ A (典型值)低电源电流
- ◆ -3dB带宽：1GHz (典型值)
- ◆ 5 $\Omega$  (典型值)低R<sub>ON</sub>
- ◆ 高阻关断模式
- ◆ 逻辑输入控制信号切换
- ◆ +1.8V CMOS逻辑兼容
- ◆ 超小型14引脚、3mm x 3mm、TDFN封装

## 应用

笔记本电脑

蜂窝电话

## 定购信息

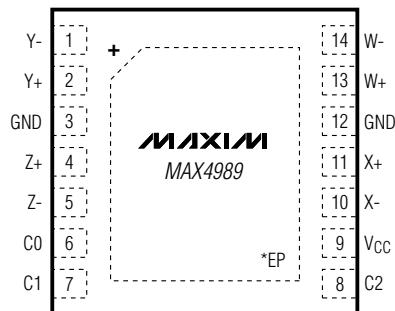
PART	TEMP RANGE	PIN-PACKAGE	PKG CODE
<b>MAX4989ETD+</b>	-40°C to +85°C	14 TDFN-EP* (3mm x 3mm)	T1433-2

+表示无铅/符合RoHS标准的封装。

\*EP = 裸焊盘。

## 引脚配置

TOP VIEW



3mm x 3mm TDFN

\*EP = EXPOSED PAD. CONNECT EP TO GROUND.



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# USB 2.0高速4选2交叉点开关

## ABSOLUTE MAXIMUM RATINGS

(Voltages referenced to GND.)

V <sub>CC</sub>	-0.3V to +6.0V
C <sub>—</sub>	-0.3V to +6.0V
W <sub>—</sub> , X <sub>—</sub> , Y <sub>—</sub> , Z <sub>—</sub>	-0.3V to (V <sub>CC</sub> + 0.3V)
Continuous Current C <sub>—</sub>	±30mA
Continuous Current W <sub>—</sub> , X <sub>—</sub> , Y <sub>—</sub> , Z <sub>—</sub>	±120mA
Peak Current W <sub>—</sub> , X <sub>—</sub> , Y <sub>—</sub> , Z <sub>—</sub> (pulsed at 1ms, 10% duty cycle)	±240mA
Continuous Power Dissipation (T <sub>A</sub> = +70°C)	
14-Pin TDFN (derate 24.4mW/°C above +70°C)	1951mW

Junction-to-Case Thermal Resistance ( $\Theta_{JC}$ ) (Note 1)

14-Pin TDFN ..... 8°C/W

Junction-to-Ambient Thermal Resistance ( $\Theta_{JA}$ ) (Note 1)

14-Pin TDFN ..... 41°C/W

Operating Temperature Range ..... -40°C to +85°C

Junction Temperature ..... +150°C

Storage Temperature Range ..... -65°C to +150°C

Lead Temperature (soldering, 10s) ..... +300°C

**Note 1:** Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a 4-layer board. For detailed information on package thermal considerations, refer to [www.maxim-ic.com.cn/thermal-tutorial](http://www.maxim-ic.com.cn/thermal-tutorial).

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## ELECTRICAL CHARACTERISTICS

(V<sub>CC</sub> = +2.7V to +5.5V, T<sub>A</sub> = -40°C to +85°C, unless otherwise noted. Typical values are at V<sub>CC</sub> = +3.3V, T<sub>A</sub> = +25°C.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Operating Power-Supply Range	V <sub>CC</sub>		2.7	5.5		V
Supply Current	I <sub>CC</sub>	Switch enabled	V <sub>CC</sub> = +3.3V	1	3.5	μA
				3	6.5	
Shutdown Supply Current	I <sub>SHDN</sub>	C1 = C2 = C3 = GND or V <sub>CC</sub>	0.1	0.5		μA
Analog Signal Range	V <sub>W_</sub> , V <sub>X_</sub> , V <sub>Y_</sub> , V <sub>Z_</sub>		0	V <sub>CC</sub>		V
On-Resistance	R <sub>ON</sub>	V <sub>IN</sub> = +3.0V, I <sub>OUT</sub> = 10mA (Note 3)	5	9		Ω
On-Resistance Match Between Channels	ΔR <sub>ON</sub>	V <sub>CC</sub> = +3.3V, V <sub>IN</sub> = +1.5V, I <sub>OUT</sub> = 10mA (Note 3)	0.5			Ω
On-Resistance Flatness	R <sub>FLAT</sub>	V <sub>CC</sub> = +3.3V, V <sub>IN</sub> = 0V to V <sub>CC</sub> , I <sub>OUT</sub> = 10mA (Notes 3, 4, 5)	0.4			Ω
Off-Leakage Current	I <sub>IN(OFF)</sub>	V <sub>CC</sub> = +5.5V, V <sub>IN</sub> = 0V or V <sub>CC</sub> , V <sub>OUT</sub> = V <sub>CC</sub> or 0V or unconnected (Note 3)	-1	+1		μA
On-Leakage Current	I <sub>IN(ON)</sub>	V <sub>CC</sub> = +5.5V, V <sub>IN</sub> = 0V or V <sub>CC</sub> , V <sub>OUT</sub> = unconnected (Note 3)	-1	+1		μA

### AC PERFORMANCE (Note 4)

On-Channel -3dB Bandwidth	BW	R <sub>L</sub> = R <sub>S</sub> = 50Ω, V <sub>IN</sub> = 0dBm, Figure 1	1	GHz
Insertion Loss	S <sub>12</sub>	R <sub>L</sub> = R <sub>S</sub> = 50Ω, f = 10MHz	0.5	dB
Off-Isolation (Note 3) Figure 1	V <sub>ISO</sub>	f = 10MHz, V <sub>IN</sub> = 0dBm, R <sub>L</sub> = R <sub>S</sub> = 50Ω	-43	dB
		f = 250MHz, V <sub>IN</sub> = 0dBm, R <sub>L</sub> = R <sub>S</sub> = 50Ω	-15	
Crosstalk	V <sub>CT</sub>	f = 50MHz, V <sub>IN</sub> = 0dBm, R <sub>L</sub> = R <sub>S</sub> = 50Ω, between adjacent pairs (Note 3), Figure 1	-50	dB

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## ELECTRICAL CHARACTERISTICS (continued)

( $V_{CC} = +2.7V$  to  $+5.5V$ ,  $T_A = -40^\circ C$  to  $+85^\circ C$ , unless otherwise noted. Typical values are at  $V_{CC} = +3.3V$ ,  $T_A = +25^\circ C$ .) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
<b>DYNAMIC (Note 4)</b>						
Turn-On Time	$t_{ON}$	$V_{IN} = +1.5V$ , $R_L = 300\Omega$ , $C_L = 35pF$ , $V_{C\_} = 0V$ to $V_{CC}$ , Figure 2	15	100		$\mu s$
Turn-Off Time	$t_{OFF}$	$V_{IN} = +1.5V$ , $R_L = 300\Omega$ , $C_L = 35pF$ , $V_{C\_} = 0V$ to $V_{CC}$ , Figure 2	2	6		$\mu s$
Propagation Delay	$t_{PLH}, t_{PHL}$	$R_L = R_S = 50\Omega$ , Figure 3	120			ps
Output Skew Between Switches	$t_{SK(O)}$	$R_L = R_S = 50\Omega$ , Figure 3	50			ps
Output Skew Same Switch	$t_{SK(P)}$	$R_L = R_S = 50\Omega$ , Figure 3	50			ps
Off-Capacitance	$C_{OFF}$	$f = 1MHz$ , $V_{BIAS} = 0V$ , $V_{IN} = 0.5V_{P-P}$	13.5			$pF$
		$f$ at $-3dB = 240MHz$ , $V_{BIAS} = 0V$ , $V_{IN} = 0.5V_{P-P}$	4			
On-Capacitance	$C_{ON}$	$f = 1MHz$ , $V_{BIAS} = 0V$ , $V_{IN} = 0.5V_{P-P}$		6		$pF$
		$f$ at $-3dB = 240MHz$ , $V_{BIAS} = 0V$ , $V_{IN} = 0.5V_{P-P}$				
<b>LOGIC INPUTS</b>						
Input Logic High	$V_{IH}$		1.7			V
Input Logic Low	$V_{IL}$			0.5		V
Input Logic Hysteresis	$V_{HYST}$		75			mV
Input Leakage Current	$I_{IN}$	$V_{CC} = +5.5V$ , $V_{C\_} = GND$ or $V_{CC}$	-1		+1	$\mu A$

**Note 2:** All devices are 100% production tested at  $T_A = +25^\circ C$ . All temperature limits are guaranteed by design.

**Note 3:** IN and OUT refer to input and output terminals ( $W\_$ ,  $X\_$ ,  $Y\_$ ,  $Z\_$ ) of any switch configuration.

**Note 4:** Not production tested. Guaranteed by design.

**Note 5:** Flatness is defined as the difference between the maximum and minimum value of on-resistance, as measured over specified analog signal ranges.

# USB 2.0高速4选2交叉点开关

测试电路/时序图

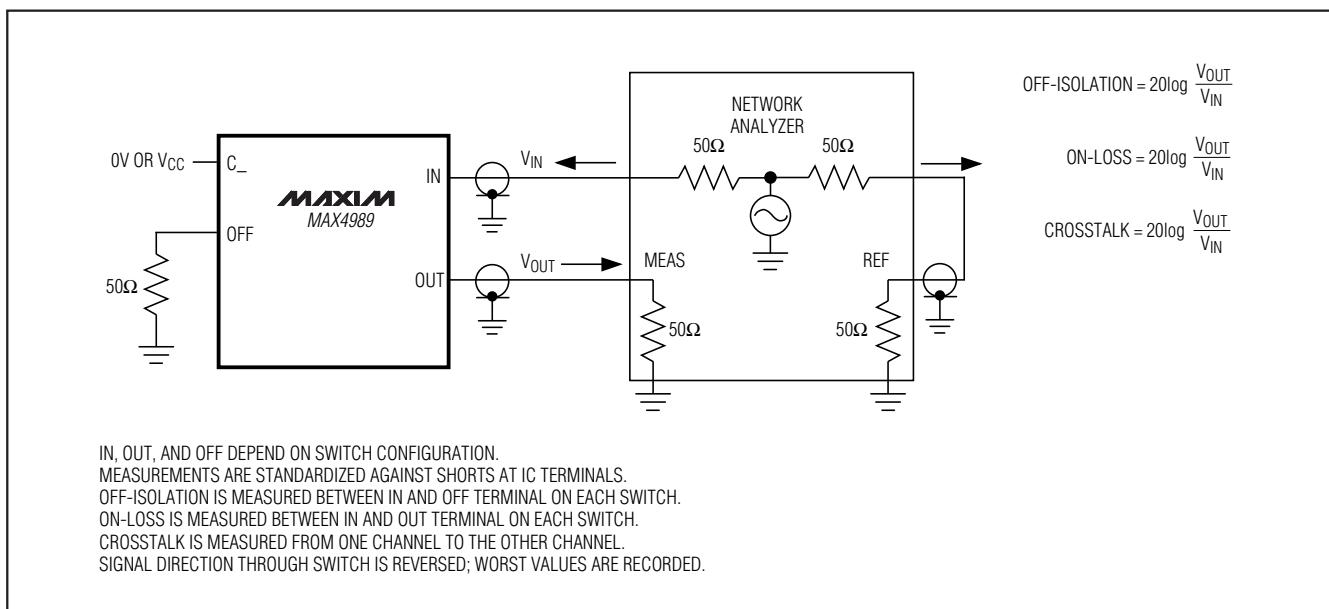


图1. 导通损耗、关断隔离和串扰

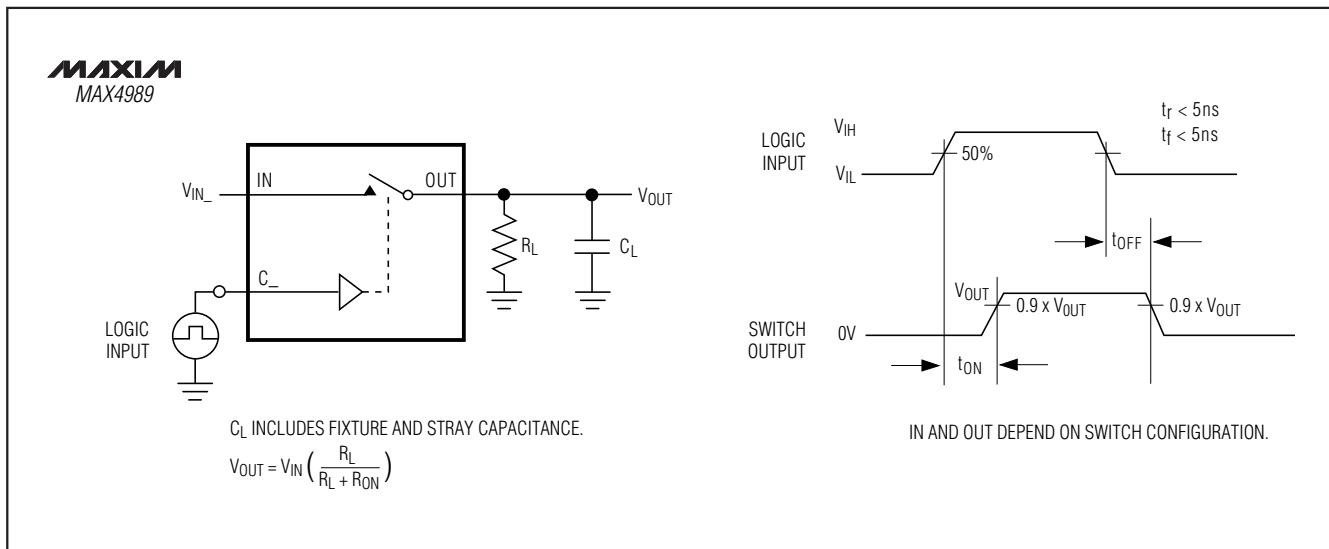


图2. 开关时间

# USB 2.0高速4选2交叉点开关

测试电路/时序图(续)

MAX4989

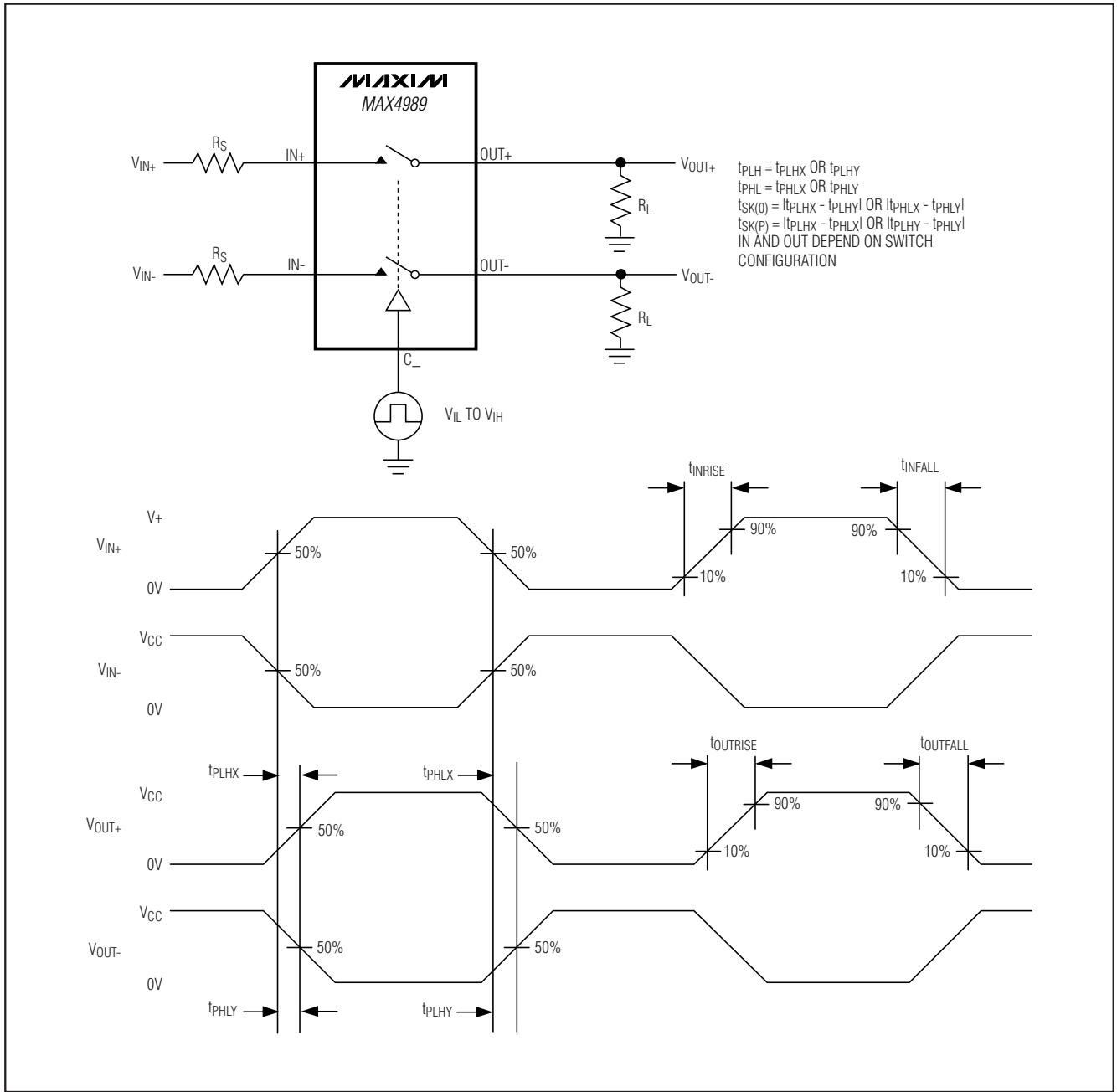
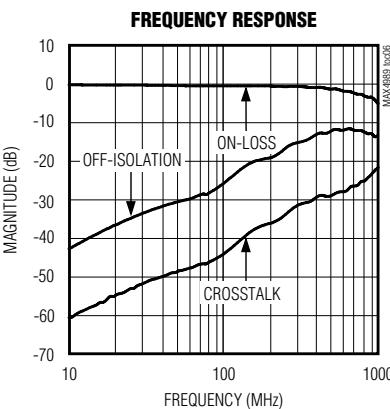
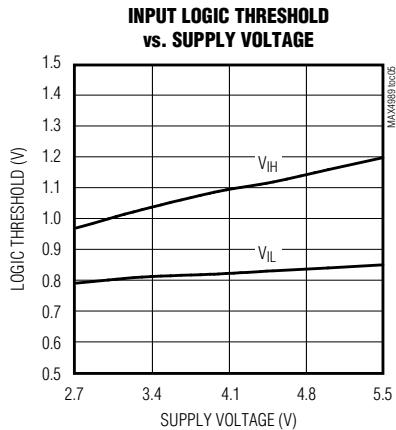
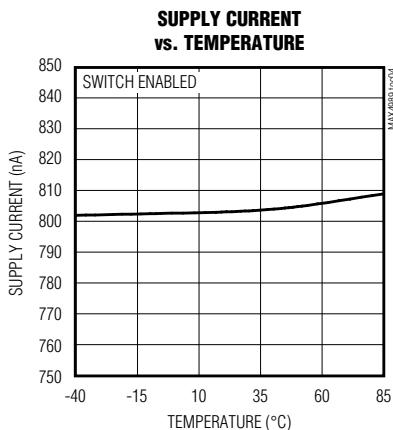
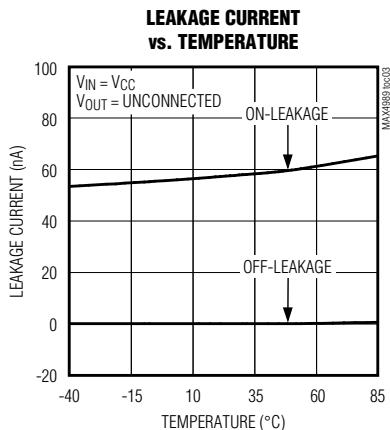
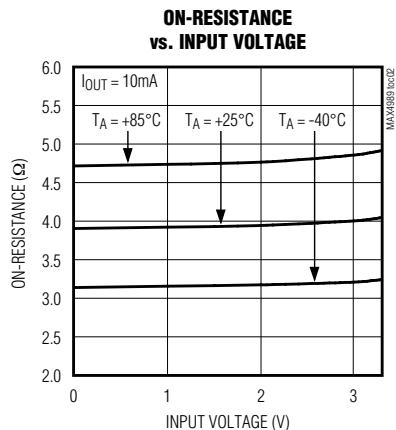
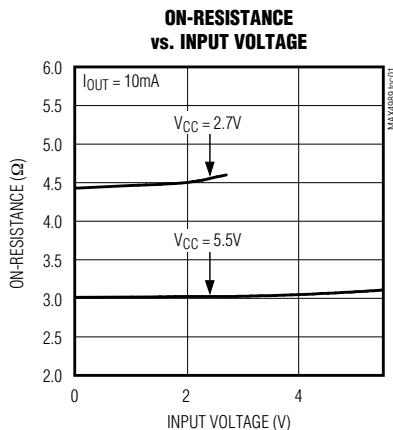


图3. 输出信号偏差、上升/下降时间、传输延迟

# USB 2.0高速4选2交叉点开关

( $V_{CC} = +3.3V$ ,  $T_A = +25^\circ C$ , unless otherwise noted.)

## 典型工作特性



# USB 2.0高速4选2交叉点开关

## 引脚说明

引脚	名称	功能
1	Y-	Y端反相输入/输出。
2	Y+	Y端同相输入/输出。
3	GND	地。
4	Z+	Z端同相输入/输出。
5	Z-	Z端反相输入/输出。
6	C0	控制输入0。
7	C1	控制输入1。
8	C2	控制输入2。
9	V <sub>CC</sub>	正电源电压输入，采用一只0.1μF的陶瓷电容将V <sub>CC</sub> 旁路至GND，并尽可能靠近器件放置。
10	X-	X端反相输入/输出。
11	X+	X端同相输入/输出。
12	GND	地。
13	W+	W端同相输入/输出。
14	W-	W端反相输入/输出。
—	EP	裸焊盘，EP可连接至GND或悬空。EP不作为电气连接点。

## 详细说明

MAX4989为USB 2.0双向交叉点开关，允许用户连接4个USB差分对的任意两个。该器件工作于+2.7V至+5.5V单电源，并具有内部电荷泵，提供满摆幅信号。支持USB低速/全速/高速应用，数据速率高达480Mbps。

### 逻辑控制输入

MAX4989提供3路控制逻辑输入：C0、C1和C2，用于控制开关连接，如功能框图/真值表所示。满摆幅驱动逻辑控制输入能够使功耗最小。

### 关断模式

MAX4989具有关断模式，可将电源电流降至0.5μA以下，并将所有开关端置于高阻态。将所有控制输入驱动到高电平或将所有控制输入驱动到低电平时，器件置于关断模式（参见功能框图/真值表。）

## USB开关

MAX4989的低导通电容和低导通电阻使其非常适合高性能高速USB 2.0开关应用。MAX4989可理想用于切换USB数据线以及需要在多个USB主机或USB设备之间进行切换的应用(图4)。

## 布局

高速USB需要仔细的PCB布局，阻抗受控的高速信号线应该具有相同长度。确保旁路电容尽可能靠近器件安装，尽量采用大面积的接地层。

## 上电顺序

**警告：**不要超出绝对最大额定参数，超出规定的额定值会对器件造成永久性损害。

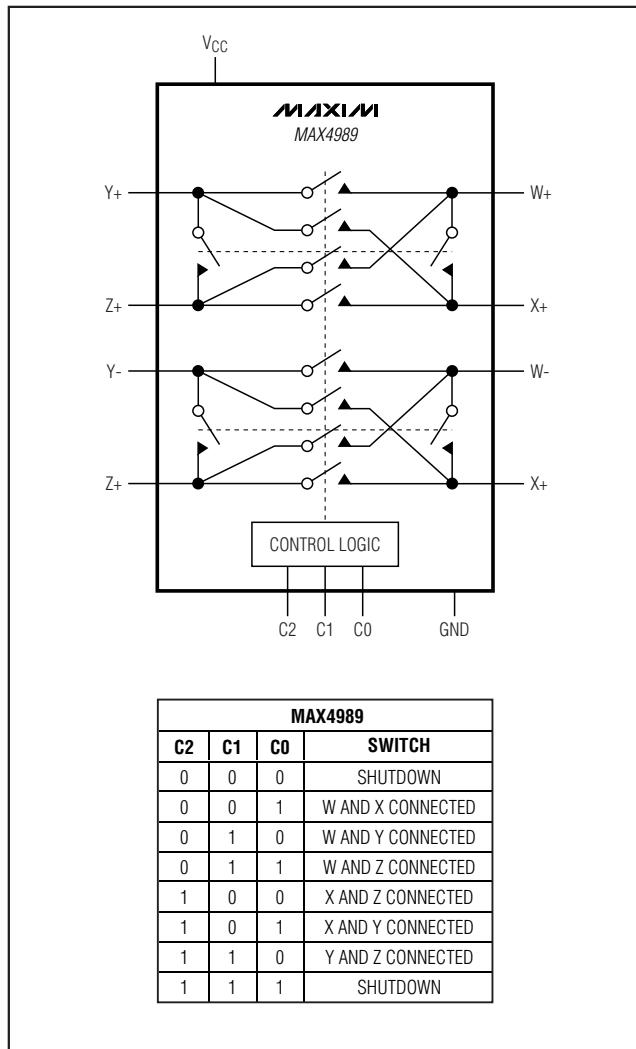
推荐所有器件采用正确的上电顺序。加载信号之前一定要先加载V<sub>CC</sub>电源，特别是对于没有限流保护的信号。

## 芯片信息

PROCESS: BiCMOS

# USB 2.0高速4选2交叉点开关

功能框图/真值表



应用信息

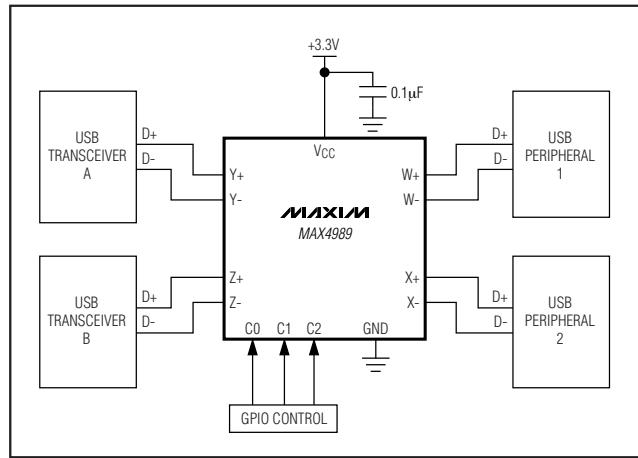


图4. 典型应用电路

封装信息

如需最近的封装外形信息和焊盘布局，请查询  
[www.maxim-ic.com.cn/packages](http://www.maxim-ic.com.cn/packages)。

封装类型	封装编码	文档编号
14 TDFN	T1433-2	<a href="#">21-0137</a>

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